

T-46-13-29



Am27C1024

1 Megabit (65,536 x 16-Bit) CMOS EPROM

**Advanced
Micro
Devices**

DISTINCTIVE CHARACTERISTICS

- High Speed Flashrite™ programming
- Fast access time — 100 ns
- Low power consumption:
— 100 μ A maximum standby current
- Programming voltage: 12.75 V
- Single +5-V power supply
- JEDEC-approved 40-pin DIP and 44 pad LCC pinouts
- $\pm 10\%$ power supply tolerance available
- Latch-up protected to 100 mA from -1 V to $V_{CC} + 1$ V

GENERAL DESCRIPTION

The Am27C1024 is a 1 megabit, ultraviolet erasable programmable read-only memory. It is organized as 64K words by 16 bits per word, operates from a single +5-V supply, has a static standby mode, and features fast single address location programming. The x16 organization makes the Am27C1024 ideal for use in 16-bit microprocessor systems. Products are available in windowed ceramic DIP and LCC packages, as well as plastic one-time programmable (OTP) packages.

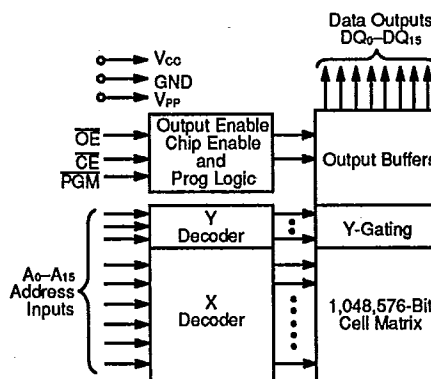
Any byte can be accessed in less than 100 ns, allowing operation with high-performance microprocessors with reduced WAIT states. The Am27C1024 offers separate Output Enable ($\overline{OE}$) and Chip Enable ($\overline{CE}$) controls, thus

eliminating bus contention in a multiple bus microprocessor system.

AMD's CMOS process technology provides high speed, low power, and high noise immunity. Typical power consumption is only 125 mW in active mode, and 350 μ W in standby mode.

All signals are TTL levels, including programming signals. Bit locations may be programmed singly, in blocks, or at random. The Am27C1024 supports AMD's Flashrite programming algorithm (100 μ s pulses) resulting in typical programming times of less than 20 seconds.

BLOCK DIAGRAM



06780-001E

PRODUCT SELECTOR GUIDE

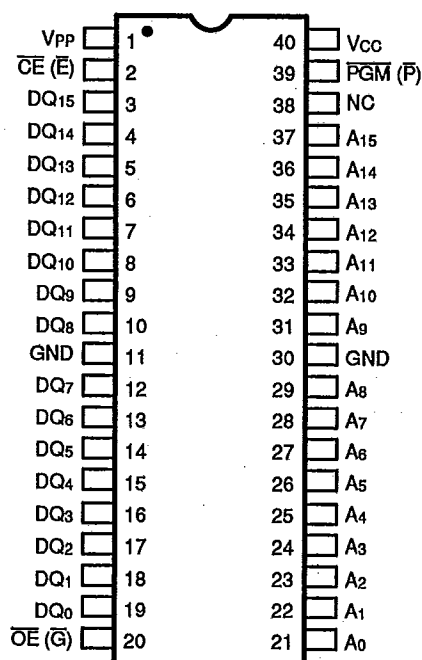
Family Part No.	Am27C1024				
Ordering Part No:					
$\pm 5\%$ Vcc Tolerance	-105	-125			-255
$\pm 10\%$ Vcc Tolerance		-120	-150	-200	-250
Max. Access Time (ns)	100	120	150	200	250
$\overline{CE}$ ($\overline{E}$) Access (ns)	100	120	150	200	250
$\overline{OE}$ ($\overline{G}$) Access (ns)	50	50	65	75	100

CONNECTION DIAGRAMS

T-46-13-29

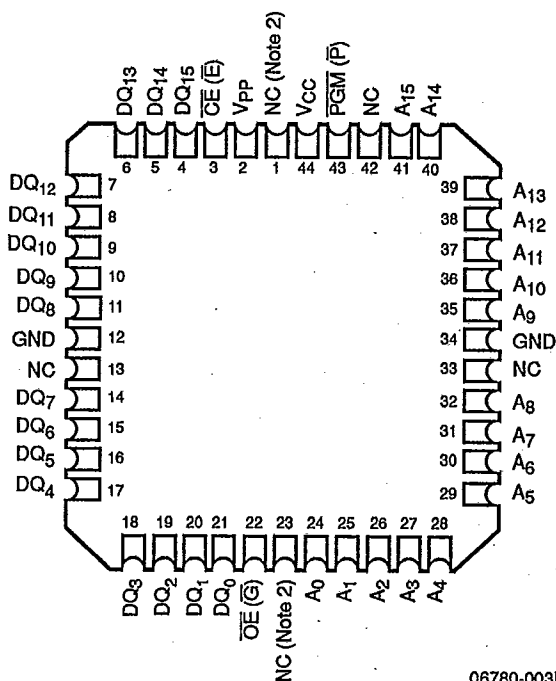
Top View

DIPs



06780-002E

LCC*



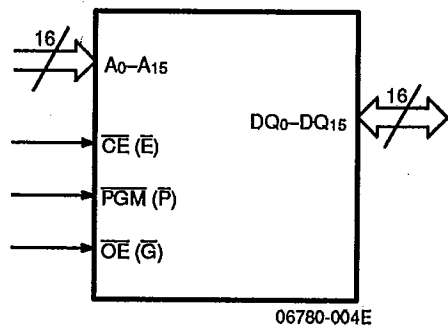
06780-003E

*Also available in a 44-Pin Plastic Leaded Chip Carrier.

Notes:

1. JEDEC nomenclature is in parenthesis.
2. Don't use (DU) for PLCC.

LOGIC SYMBOL



PIN DESCRIPTION

A ₀ -A ₁₅	V _{CC}
Address Inputs	V _{CC} Supply Voltage
$\overline{CE}$ ($\overline{E}$)	V _{PP}
Chip Enable Input	Program Supply Voltage
DQ ₀ -DQ ₁₅	GND
Data Input/Outputs	Ground
$\overline{OE}$ ($\overline{G}$)	NC
Output Enable Input	No Internal Connect
PGM ($\overline{P}$)	DU
Program Enable Input	No External Connect

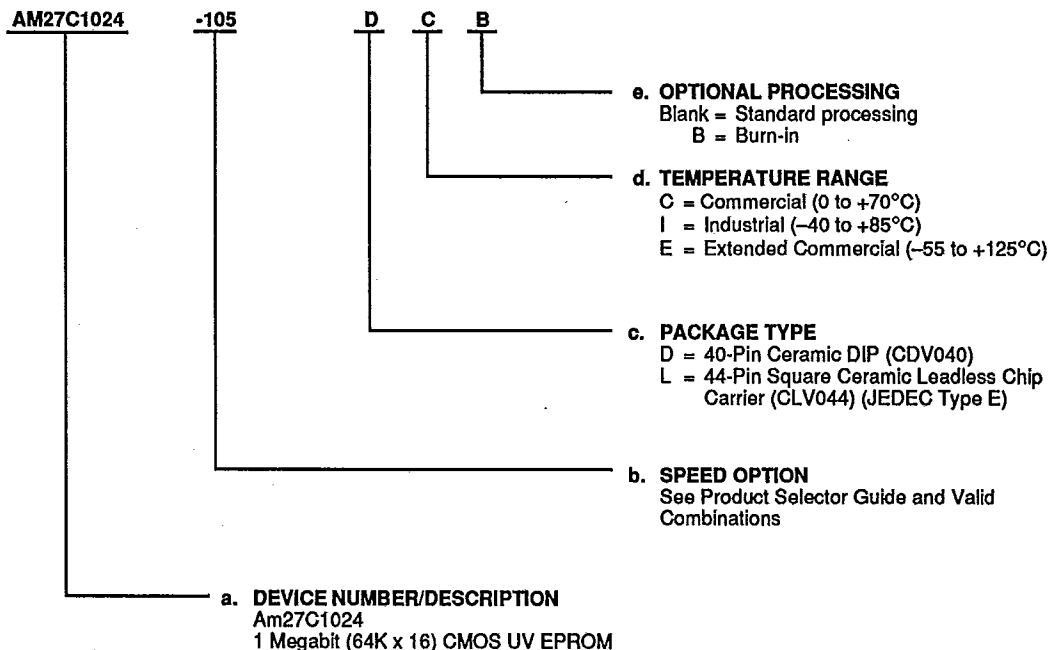
ORDERING INFORMATION

T-46-13-29

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:

- a. Device Number
- b. Speed Option
- c. Package Type
- d. Temperature Range
- e. Optional Processing



Valid Combinations	
AM27C1024-105	DC, DCB, DI, DIB,
AM27C1024-125	LC, LCB, LI, LIB
AM27C1024-120	DC, DCB, DI,
AM27C1024-150	DIB, DE, DEB,
AM27C1024-200	LCB, LIB, LE,
AM27C1024-255	LEB, LC, LI

Valid Combinations

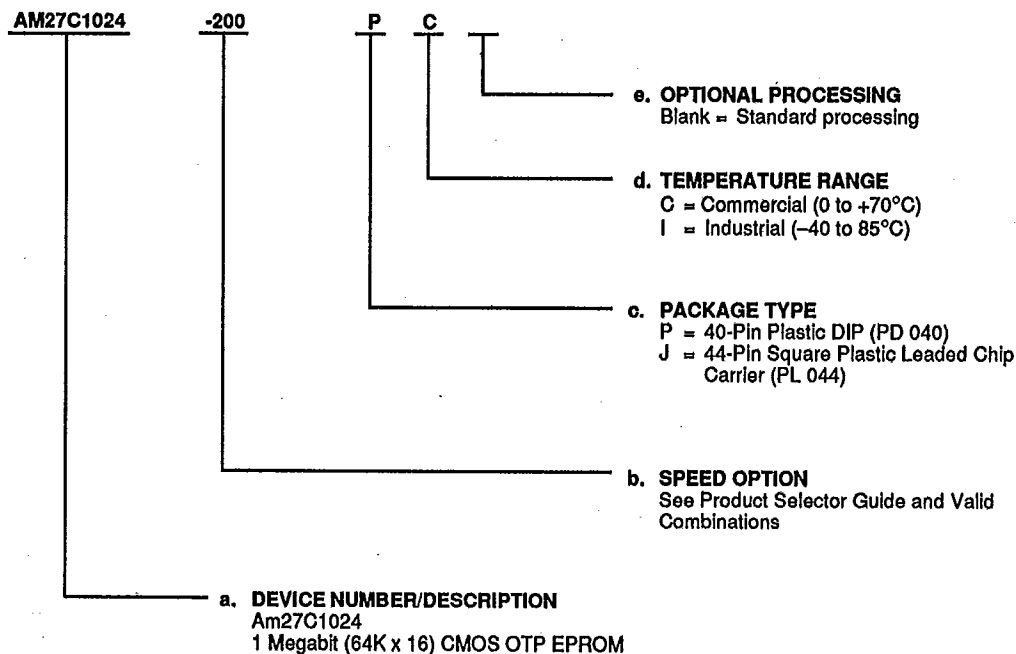
Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check on newly released combinations.

ORDERING INFORMATION**OTP Products**

T-46-13-29

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:

- a. Device Number
- b. Speed Option
- c. Package Type
- d. Temperature Range
- e. Optional Processing



Valid Combinations	
AM27C1024-200	PC, JC, PI, JI
AM27C1024-255	

Valid Combinations

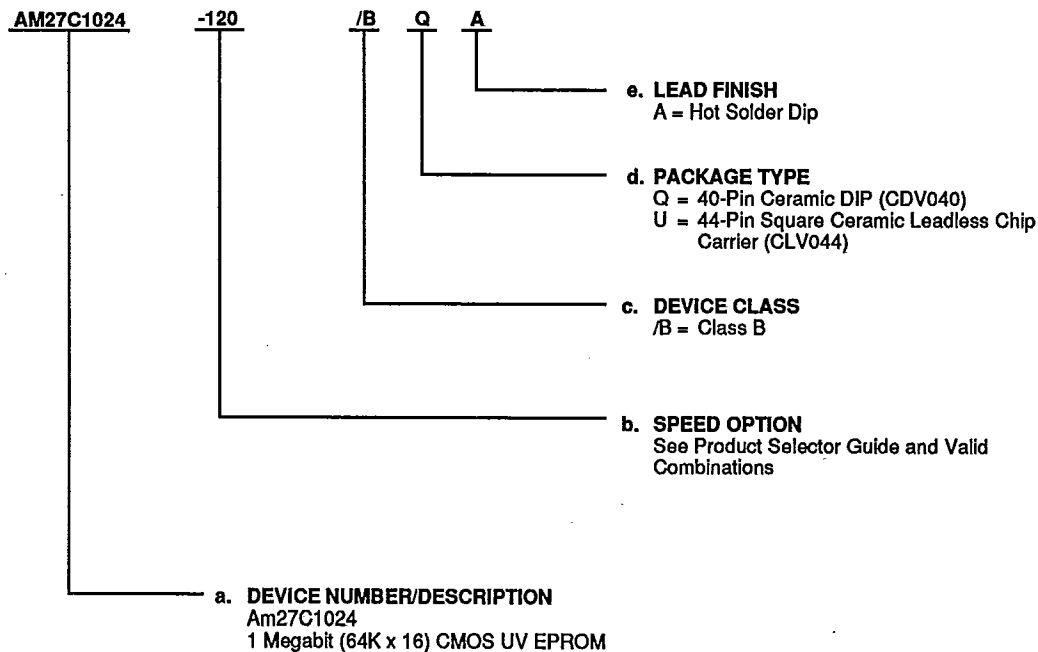
Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check on newly released combinations.

MILITARY ORDERING INFORMATION**APL Products**

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AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) is formed by a combination of:

- a. Device Number
- b. Speed Option
- c. Device Class
- d. Package Type
- e. Lead Finish



Valid Combinations	
AM27C1024-120	/BQA, /BUA
AM27C1024-150	
AM27C1024-200	
AM27C1024-250	

For other Surface Mount Package options, contact NVD Military Marketing.

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, or to check on newly released combinations.

Group A Tests

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

FUNCTIONAL DESCRIPTION

Erasing the Am27C1024

In order to clear all locations of their programmed contents, it is necessary to expose the Am27C1024 to an ultraviolet light source. A dosage of 15 W seconds/cm² is required to completely erase an Am27C1024. This dosage can be obtained by exposure to an ultraviolet lamp — wavelength of 2537 Angstroms (Å) — with intensity of 12,000 μW/cm² for 15 to 20 minutes. The Am27C1024 should be directly under and about one inch from the source and all filters should be removed from the UV light source prior to erasure.

It is important to note that the Am27C1024, and similar devices, will erase with light sources having wavelengths shorter than 4000 Å. Although erasure times will be much longer than with UV sources at 2537 Å, nevertheless the exposure to fluorescent light and sunlight will eventually erase the Am27C1024 and exposure to them should be prevented to realize maximum system reliability. If used in such an environment, the package window should be covered by an opaque label or substance.

Programming the Am27C1024

Upon delivery, or after each erasure, the Am27C1024 has all 1,048,576 bits in the "ONE", or HIGH state. "ZEROS" are loaded into the Am27C1024 through the procedure of programming.

The programming mode is entered when 12.75 ± 0.25 V is applied to the V_{PP} pin, and $\overline{CE}$ and $\overline{PGM}$ are at V_{IL} .

For programming, the data to be programmed is applied 16 bits in parallel to the data pins.

The Flashrite programming algorithm (shown in Figure 1) reduces programming time by using initial 100 μs pulses followed by a byte verification to determine whether the byte has been successfully programmed. If the data does not verify, an additional pulse is applied for a maximum of 25 pulses. This process is repeated while sequencing through each address of the EPROM.

The Flashrite programming algorithm programs and verifies at $V_{CC} = 6.25$ V and $V_{PP} = 12.75$ V. After the final address is completed, all bytes are compared to the original data with $V_{CC} = V_{PP} = 5.25$ V.

Program Inhibit

Programming of multiple Am27C1024s in parallel with different data is also easily accomplished. Except for $\overline{CE}$, all like inputs of the parallel Am27C1024 may be common. A TTL low-level program pulse applied to an Am27C1024 $\overline{CE}$ input with $V_{PP} = 12.75 \pm .25$ V and $\overline{PGM}$ LOW will program that Am27C1024. A high-level $\overline{CE}$ input inhibits the other Am27C1024s from being programmed.

Program Verify

A verify should be performed on the programmed bits to determine that they were correctly programmed. The

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verify should be performed with $\overline{OE}$ and $\overline{CE}$, at V_{IL} , $\overline{PGM}$ at V_{IH} , and V_{PP} between $12.75 \text{ V} \pm .25 \text{ V}$.

Auto Select Mode

The auto select mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically matching the device to be programmed with its corresponding programming algorithm. This mode is functional in the $25^\circ\text{C} \pm 5^\circ\text{C}$ ambient temperature range that is required when programming the Am27C1024.

To activate this mode, the programming equipment must force 12.0 ± 0.5 V on address line A_9 of the Am27C1024. Two identifier bytes may then be sequenced from the device outputs by toggling address line A_0 from V_{IL} to V_{IH} . All other address lines must be held at V_{IL} during auto select mode.

Byte 0 ($A_0 = V_{IL}$) represents the manufacturer code, and Byte 1 ($A_0 = V_{IH}$), the device identifier code. For the Am27C1024, these two identifier bytes are given in the Mode Select table. All identifiers for manufacturer and device codes will possess odd parity, with the MSB (DQ₇) defined as the parity bit.

Read Mode

The Am27C1024 has two control functions, both of which must be logically satisfied in order to obtain data at the outputs. Chip Enable ($\overline{CE}$) is the power control and should be used for device selection. Output Enable ($\overline{OE}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (t_{acc}) is equal to the delay from $\overline{CE}$ to output (t_{ce}). Data is available at the outputs t_{oe} after the falling edge of $\overline{OE}$, assuming that $\overline{CE}$ has been LOW and addresses have been stable for at least $t_{acc} - t_{oe}$.

Standby Mode

The Am27C1024 has a CMOS standby mode which reduces the maximum V_{CC} current to 100 μA. It is placed in CMOS-standby when $\overline{CE}$ is at $V_{CC} \pm 0.3$ V. The Am27C1024 also has a TTL-standby mode which reduce the maximum V_{CC} current to 1.0 mA. It is placed in TTL-standby when $\overline{CE}$ is at V_{IH} . When in standby mode, the outputs are in a high-impedance state, independent of the $\overline{OE}$ input.

Output OR-Tieing

To accommodate multiple memory connections, a two-line control function is provided to allow for:

1. Low memory power dissipation, and
2. Assurance that output bus contention will not occur.

It is recommended that $\overline{CE}$ be decoded and used as the primary device-selecting function, while $\overline{OE}$ be made a

common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low-power standby mode and that the output pins are only active when data is desired from a particular memory device.

System Applications

During the switch between active and standby conditions, transient current peaks are produced on the rising and falling edges of Chip Enable. The magnitude of

these transient current peaks is dependent on the output capacitance loading of the device. At a minimum, a 0.1- μ F ceramic capacitor (high frequency, low inherent inductance) should be used on each device between V_{CC} and GND to minimize transient effects. In addition, to overcome the voltage drop caused by the inductive effects of the printed circuit board traces on EPROM arrays, a 4.7- μ F bulk electrolytic capacitor should be used between V_{CC} and GND for each eight devices. The location of the capacitor should be close to where the power supply is connected to the array.

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Mode Select Table

Mode \ Pins		$\overline{CE}$	$\overline{OE}$	$\overline{PGM}$	A ₀	A ₉	V _{PP}	Outputs
Read		V _{IL}	V _{IL}	V _{IH}	X	X	V _{CC}	D _{OUT}
Output Disable		V _{IL}	V _{IH}	V _{IH}	X	X	V _{CC}	High Z
Standby (TTL)		V _{IH}	X	X	X	X	V _{CC}	High Z
Standby (CMOS)		V _{CC} $\pm$ 0.3 V	X	X	X	X	V _{CC}	High Z
Program		V _{IL}	X	V _{IL}	X	X	V _{PP}	D _{IN}
Program Verify		V _{IL}	V _{IL}	V _{IH}	X	X	V _{PP}	D _{OUT}
Program Inhibit		V _{IH}	X	X	X	X	V _{PP}	High Z
Auto Select (Note 3)	Manufacturer Code	V _{IL}	V _{IL}	V _{IH}	V _{IL}	V _H	V _{CC}	01H
	Device Code	V _{IL}	V _{IL}	V _{IH}	V _{IH}	V _H	V _{CC}	8CH

Notes:

1. X can be either V_{IL} or V_{IH}
2. V_H = 12.0 V $\pm$ 0.5 V
3. A₁ - A₈ = A₁₀ - A₁₅ = V_{IL}
4. See DC Programming Characteristics for V_{PP} voltage during programming.

ABSOLUTE MAXIMUM RATINGS**Storage Temperature:**

OTP Products	-65 to +125°C
All Other Products	-65 to +150°C

Ambient Temperature with Power Applied

-55 to +125°C

Voltage with Respect to Ground:All pins except A₉, V_{PP}, andV_{CC} (Note 1) -0.6 to V_{CC} + 0.6 VA₉ and V_{PP} (Note 2) -0.6 to 13.5 VV_{CC} -0.6 to 7.0 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

OPERATING RANGES

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Commercial (C) DevicesCase Temperature (T_C) 0 to +70°C**Industrial (I) Devices**Case Temperature (T_C) -40 to +85°C**Extended Commercial (E) Devices**Case Temperature (T_C) -55 to +125°C**Military (M) Devices**Case Temperature (T_C) -55 to +125°C**Supply Read Voltages:**V_{CC}/V_{PP} for Am27C1024-XX5 +4.75 to +5.25 VV_{CC}/V_{PP} for Am27C1024-XX0 +4.50 to +5.50 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Notes:

1. During transitions, the input may overshoot GND to -2.0 V for periods of up to 20 ns. Maximum DC voltage on input and I/O may overshoot to V_{CC} + 2.0 V for periods up to 20 ns.
2. During transitions, A₉ and V_{PP} may overshoot GND to -2.0 V for periods of up to 20 ns. A₉ and V_{PP} must not exceed 13.5 V for any period of time.

DC CHARACTERISTICS over operating ranges unless otherwise specified
(Notes 1, 4, 5 & 8)

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Parameter Symbol	Parameter Description	Test Conditions		Min.	Max.	Unit
TTL and NMOS Inputs						
V _{OH}	Output HIGH Voltage	I _{OH} = −400 μA		2.4		V
V _{OL}	Output LOW Voltage	I _{OL} = 2.1 mA			0.45	V
V _{IH}	Input HIGH Voltage			2.0	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage			−0.5	+0.8	V
I _{LI}	Input Load Current	V _{IN} = 0 V to V _{CC}	C/I Devices		1.0	μA
			E/M Devices		5.0	
I _{LO}	Output Leakage Current	V _{OUT} = 0 V to V _{CC}	C/I Devices		10	μA
			E/M Devices		10	
I _{CC1}	V _{CC} Active Current (Note 5)	$\overline{CE} = V_{IL}$, f = 5 MHz, I _{OUT} = 0 mA (Open Outputs)	C/I Devices		50	mA
			E/M Devices		60	
I _{CC2}	V _{CC} Standby Current	$\overline{CE} = V_{IH}$,	C/I Devices		1.0	mA
		$\overline{OE} = V_{IL}$	E/M Devices		1.5	
I _{PP1}	V _{PP} Supply Current (Read)	$\overline{CE} = \overline{OE} = V_{IL}$, V _{PP} = V _{CC}			100	μA
CMOS Inputs						
V _{OH}	Output HIGH Voltage	I _{OH} = −400 μA		2.4		V
V _{OL}	Output LOW Voltage	I _{OL} = 2.1 mA			0.45	V
V _{IH}	Input HIGH Voltage			V _{CC} − 0.3	V _{CC} + 0.3	V
V _{IL}	Input LOW Voltage			−0.5	+0.8	V
I _{LI}	Input Load Current	V _{IN} = 0 V to V _{CC}	C/I Devices		1.0	μA
			E/M Devices		5.0	
I _{LO}	Output Leakage Current	V _{OUT} = 0 V to V _{CC}	C/I Devices		10	μA
			E/M Devices		10	
I _{CC1}	V _{CC} Active Current (Note 5)	$\overline{CE} = V_{IL}$, f = 5 MHz, I _{OUT} = 0 mA (Open Outputs)	C/I Devices		50	mA
			E/M Devices		60	
I _{CC2}	V _{CC} Standby Current	$\overline{CE} = V_{CC} \pm 0.3\text{ V}$	C/I Devices		100	μA
			E/M Devices		100	
I _{PP1}	V _{PP} Supply Current (Read) (Note 6)	$\overline{CE} = \overline{OE} = V_{IL}$, V _{PP} = V _{CC}			100	μA

CAPACITANCE (Notes 2, 3, & 7)

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Parameter Symbol	Parameter Description	Test Conditions	CDV040		CLV044		Unit
			Typ.	Max.	Typ.	Max.	
C _{IN1}	Address Input Capacitance	V _{IN} = 0 V	6	10	6	9	pF
C _{IN2}	$\overline{OE}$ Input Capacitance	V _{IN} = 0 V	10	12	7	9	pF
C _{IN3}	$\overline{OE}$ & PGM Input Capacitance	V _{IN} = 0 V	10	12	7	9	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0 V	8	14	6	9	pF

Notes:

1. V_{CC} must be applied simultaneously or before V_{PP}, and removed simultaneously or after V_{PP}.
2. Typical values are for nominal supply voltages.
3. This parameter is only sampled and not 100% tested.
4. **Caution:** The Am27C1024 must not be removed from, or inserted into, a socket or board when V_{PP} or V_{CC} is applied.
5. I_{CC1} is tested with $\overline{OE}$ = V_{IH} to simulate open outputs.
6. Maximum active power usage is the sum of I_{CC} and I_{PP}.
7. T_A = 25°C, f = 1 MHz.
8. Minimum DC input voltage is -0.5 V. During transitions, the inputs may overshoot to -2.0 V for periods less than 20 ns. Maximum DC voltage on output pins is V_{CC} + 0.5 V which may overshoot to V_{CC} + 2.0 V for periods less than 20 ns.

SWITCHING CHARACTERISTICS over operating ranges unless otherwise specified
(Notes 1, 3, & 4)

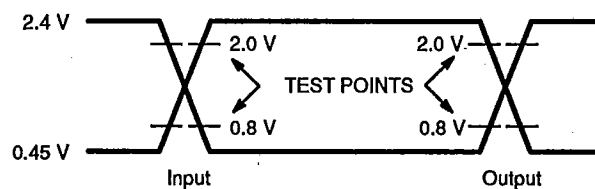
JEDEC	Standard	Parameter Description	Test Conditions	Am27C1024					Unit
				-105	-120, -125	-150	-200	-255, -250	
t _{AVQV}	t _{ACC}	Address to Output Delay	$\overline{OE} = \overline{OE} = V_{IL}$	Min.					ns
				Max.	100	120	150	200	
t _{ELQV}	t _{CE}	Chip Enable to Output Delay	$\overline{OE} = V_{IL}$	Min.					ns
				Max.	100	120	150	200	
t _{GLQV}	t _{OE}	Output Enable to Output Delay	$\overline{OE} = V_{IL}$	Min.					ns
				Max.	50	50	65	75	
t _{EHQZ} , t _{GHQZ}	t _{DF}	Output Enable HIGH to Output Float (Note 2)		Min.	0	0	0	0	ns
				Max.	40	50	55	60	
t _{AXQX}	t _{OH}	Output Hold from Addresses, $\overline{OE}$, or $\overline{OE}$, whichever occurred first		Min.	0	0	0	0	ns
				Max.					

Notes:

1. V_{CC} must be applied simultaneously or before V_{PP}, and removed simultaneously or after V_{PP}.
2. This parameter is only sampled and not 100% tested.
3. **Caution:** The Am27C1024 must not be removed from, or inserted into, a socket or board when V_{PP} or V_{CC} is applied.
4. Output Load: 1 TTL gate and C_L = 100 pF, Input Rise and Fall Times: 20 ns, Input Pulse Levels: 0.45 to 2.4 V, Timing Measurement Reference Level—Inputs: 0.8 V and 2 V, Outputs: 0.8 V and 2 V.

SWITCHING TEST WAVEFORM

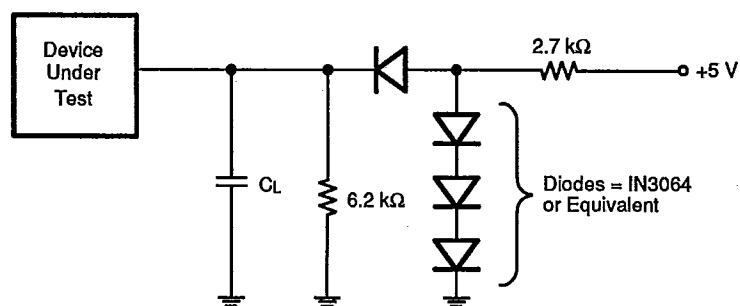
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AC Testing: Input are driven at 2.4 V for a Logic "1" and 0.45 for a Logic "0". Input pulse rise and fall times are ≤ 20 ns.

SWITCHING TEST CIRCUIT

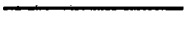
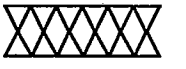
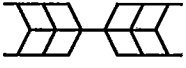


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$C_L = 100$ pF including jig capacitance

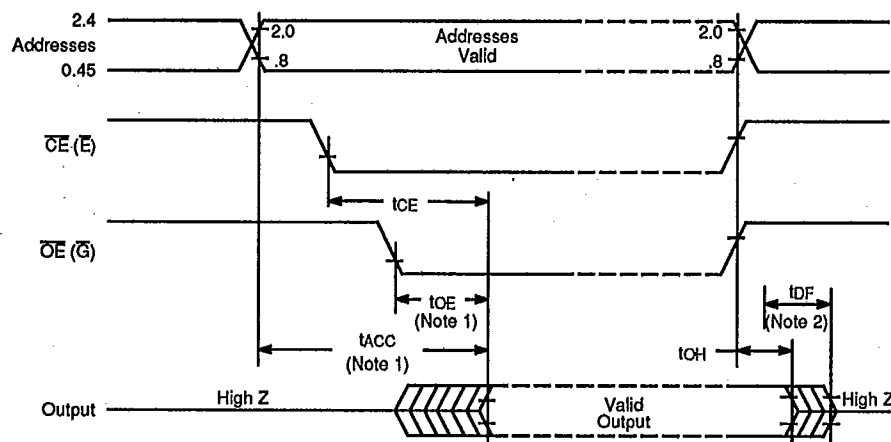
KEY TO SWITCHING WAVEFORMS

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WAVEFORM	INPUTS	OUTPUTS
	Must Be Steady	Will Be Steady
	May Change from H to L	Will Be Changing from H to L
	May Change from L to H	Will Be Changing from L to H
	Don't Care, Any Change Permitted	Changing, State Unknown
	Does Not Apply	Center Line is High Impedance "Off" State

KS000010

SWITCHING WAVEFORM



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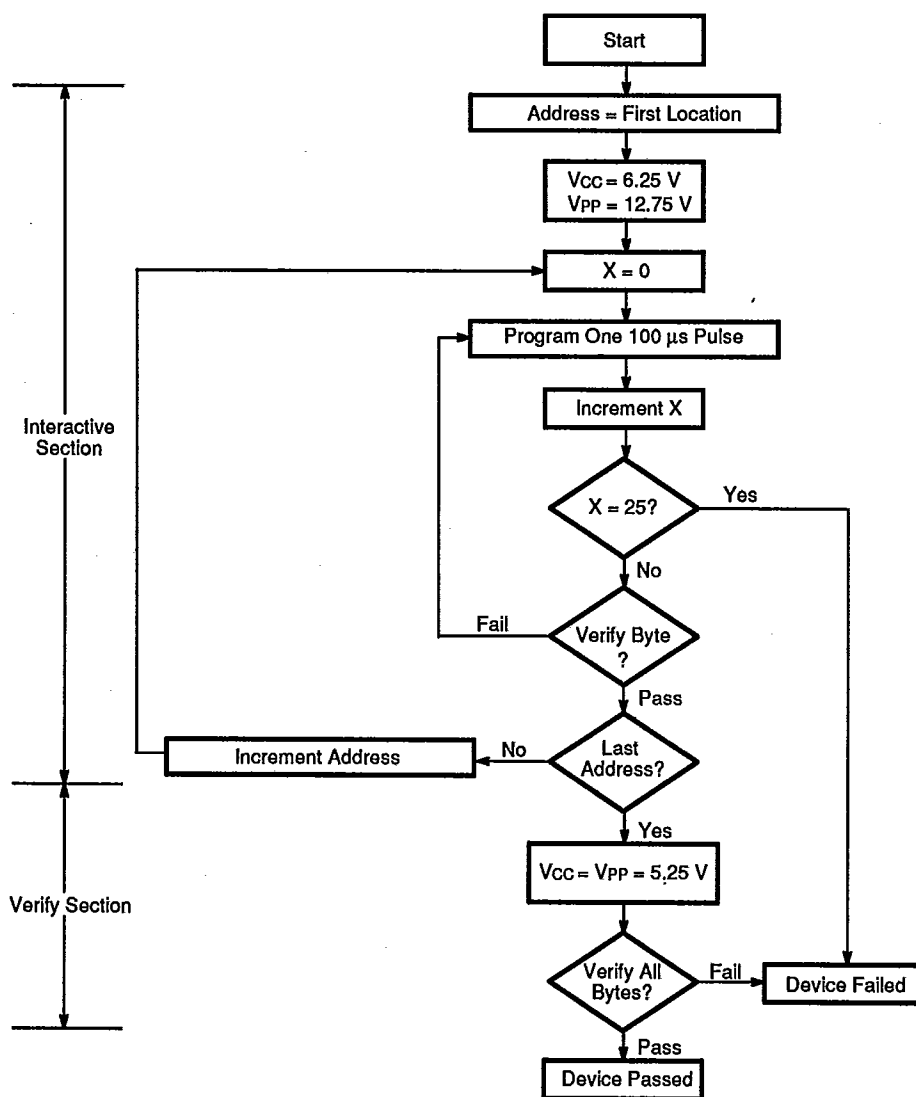
Notes:

1. $\overline{OE}$ ($\overline{G}$) may be delayed up to $t_{ACC} - t_{OE}$ after the falling edge of $\overline{OE}$ ($\overline{E}$) without impact on t_{acc} .
2. t_{DF} is specified from $\overline{OE}$ or $\overline{CE}$, whichever occurs first.

Read Cycle

PROGRAMMING FLOW CHART

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06780-008E

Figure 1. Flashrite Programming Flow Chart

DC PROGRAMMING CHARACTERISTICS ($T_A = +25^\circ\text{C} \pm 5^\circ\text{C}$) (Notes 1, 2, & 3) T-46-13-29

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
I_{LI}	Input Current (All Inputs)	$V_{IN} = V_{IL} \text{ or } V_{IH}$		10.0	μA
V_{IL}	Input LOW Level (All Inputs)		-0.3	0.8	V
V_{IH}	Input HIGH Level		2.0	$V_{CC} + 0.5$	V
V_{OL}	Output LOW Voltage During Verify	$I_{OL} = 2.1 \text{ mA}$		0.45	V
V_{OH}	Output HIGH Voltage During Verify	$I_{OH} = -400 \mu\text{A}$	2.4		V
V_H	A_9 Auto Select Voltage		11.5	12.5	V
I_{CC3}	V_{CC} Supply Current (Program & Verify)			50	mA
I_{PP2}	V_{PP} Supply Current (Program)	$\overline{CE} = V_{IL}, \overline{OE} = V_{IH}$		50	mA
V_{CC}	Flashrite Supply Voltage		6.00	6.50	V
V_{PP}	Flashrite Programming Voltage		12.5	13.0	V

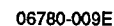
SWITCHING PROGRAMMING CHARACTERISTICS ($T_A = +25^\circ\text{C} \pm 5^\circ\text{C}$) (Notes 1, 2, & 3)

Parameter Symbols		Parameter Description	Min.	Max.	Unit
JEDEC	Standard				
t_{AVAL}	t_{AS}	Address Setup Time	2		μs
t_{DZGL}	t_{OES}	$\overline{OE}$ Setup Time	2		μs
t_{DVEL}	t_{DS}	Data Setup Time	2		μs
t_{GHAX}	t_{AH}	Address Hold Time	0		μs
t_{EHDX}	t_{DH}	Data Hold Time	2		μs
t_{GHQZ}	t_{DFP}	Output Enable to Output Float Delay	0	130	ns
t_{VPS}	t_{VPS}	V_{PP} Setup Time	2		μs
t_{ELEH}	t_{PW}	PGM Program Pulse Width	95	105	μs
t_{VCS}	t_{VCS}	V_{CC} Setup Time	2		μs
t_{ELPL}	t_{CES}	$\overline{CE}$ Setup Time	2		μs
t_{GLQV}	t_{OE}	Data Valid from $\overline{OE}$		150	ns

Notes:

1. V_{CC} must be applied simultaneously or before V_{PP} , and removed simultaneously or after V_{PP} .
2. When programming the Am27C1024, a 0.1- μF capacitor is required across V_{PP} and ground to suppress spurious voltage transients which may damage the device.
3. Programming characteristics are sampled but not 100% tested at worst-case conditions.

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1. The input timing reference level is 0.8 for V_{IL} and 2 V for V_{IH} .

2. **TOE and tDFP are characteristics of the device, but must be accommodated by the programmer.**